

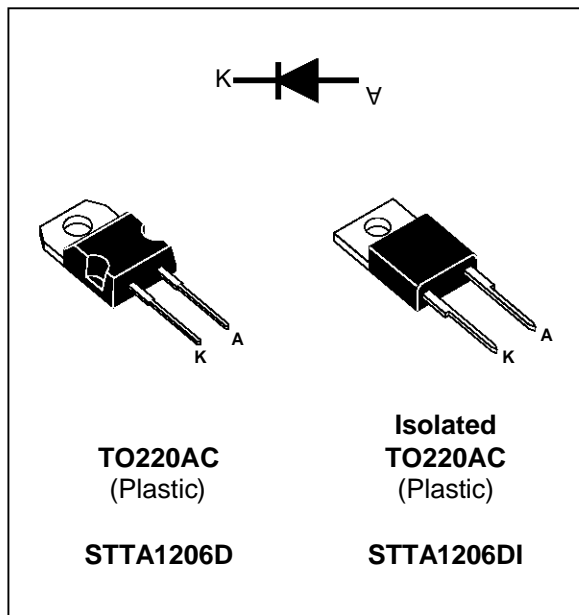
TURBOSWITCH™ "A". ULTRA-FAST HIGH VOLTAGE DIODE

MAIN PRODUCTS CHARACTERISTICS

$I_{F(AV)}$	12A
V_{RRM}	600V
t_{rr} (typ)	28ns
V_F (max)	1.5V

FEATURES AND BENEFITS

- SPECIFIC TO "FREEWHEEL MODE" OPERATIONS: Freewheel or Booster Diode.
- ULTRA-FAST RECOVERY.
- VERY LOW OVERALL POWER LOSSES IN BOTH THE DIODE AND THE COMPANION TRANSISTOR.
- HIGH FREQUENCY OPERATIONS.
- CECC APPROVED



DESCRIPTION

The TURBOSWITCH is a very high performance series of ultra-fast high voltage power diodes from 600V to 1200V.

TURBOSWITCH, A family, drastically cuts losses in both the diode and the associated switching IGBT or MOSFET in all "Freewheel Mode" operations and is particularly suitable and efficient

in Motor Control Freewheel applications and in Booster diode applications in Power Factor Control circuitries.

Packaged in TO220AC and in isolated TO220AC, these 600V devices are particularly intended for use on 240V domestic mains.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		600	V
V_{RSM}	Non repetitive peak reverse voltage		600	V
$I_{F(RMS)}$	RMS forward current	STTA1206D STTA1206DI	30 20	A
I_{FRM}	Repetitive peak forward current ($t_p = 5 \mu s, f = 5kHz$)	STTA1206D STTA1206DI	140 120	A
T_j	Max operating junction temperature		-65 to 150	°C
T_{stg}	Storage temperature		-65 to 150	°C

TM : TURBOSWITCH is a trademark of SGS-THOMSON MICROELECTRONICS.

STTA1206D(I)

THERMAL AND POWER DATA

Symbol	Parameter	Conditions	Value	Unit
$R_{th(j-c)}$	Junction to case thermal resistance	STTA1206D STTA1206DI	1.9 3.0	$^{\circ}\text{C}/\text{W}$
P_1	Conduction power dissipation (see fig. 2)	$I_{F(AV)} = 12\text{A}$ $\delta = 0.5$ STTA1206D $T_c = 108^{\circ}\text{C}$ STTA1206DI $T_c = 84^{\circ}\text{C}$	22	W
P_{max}	Total power dissipation $P_{max} = P_1 + P_3$ ($P_3 = 10\% P_1$)	STTA1206D $T_c = 104^{\circ}\text{C}$ STTA1206DI $T_c = 78^{\circ}\text{C}$	24	W

STATIC ELECTRICAL CHARACTERISTICS (see Fig.2)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_F *	Forward voltage drop	$I_F = 12\text{A}$ $T_j = 25^{\circ}\text{C}$ $T_j = 125^{\circ}\text{C}$			1.75 1.5	V V
I_R **	Reverse leakage current	$V_R = 0.8$ $\times V_{RRM}$ $T_j = 25^{\circ}\text{C}$ $T_j = 125^{\circ}\text{C}$			100 5	μA mA

Test pulses widths : * $t_p = 380 \mu\text{s}$, duty cycle < 2%

** $t_p = 5 \text{ms}$, duty cycle < 2%

DYNAMIC ELECTRICAL CHARACTERISTICS

TURN-OFF SWITCHING (see Fig.3)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
t_{rr}	Reverse recovery time	$T_j = 25^{\circ}\text{C}$ $I_F = 0.5 \text{A}$ $I_R = 1\text{A}$ $I_{rr} = 0.25\text{A}$ $I_F = 1 \text{A}$ $di_F/dt = -50\text{A}/\mu\text{s}$ $V_R = 30\text{V}$		28	55	ns
I_{RM}	Maximum reverse recovery current	$T_j = 125^{\circ}\text{C}$ $V_R = 400\text{V}$ $I_F = 12\text{A}$ $di_F/dt = -96 \text{A}/\mu\text{s}$ $di_F/dt = -500 \text{A}/\mu\text{s}$		16	7.5	A
S factor	Softness factor	$T_j = 125^{\circ}\text{C}$ $V_R = 400\text{V}$ $I_F = 12\text{A}$ $di_F/dt = -500 \text{A}/\mu\text{s}$		0.45		/

TURN-ON SWITCHING (see Fig.4)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
t_{fr}	Forward recovery time	$T_j = 25^{\circ}\text{C}$ $I_F = 12 \text{A}$, $di_F/dt = 96 \text{A}/\mu\text{s}$ measured at, $1.1 \times V_{Fmax}$			500	ns
V_{Fp}	Peak forward voltage	$T_j = 25^{\circ}\text{C}$ $I_F = 12\text{A}$, $di_F/dt = 96 \text{A}/\mu\text{s}$			10	V

APPLICATION DATA

The TURBOSWITCH "A" is especially designed to provide the lowest overall power losses in any "FREEWHEEL Mode" application (Fig.1) considering both the diode and the companion

transistor, thus optimizing the overall performance in the end application.

The way of calculating the power losses is given below:

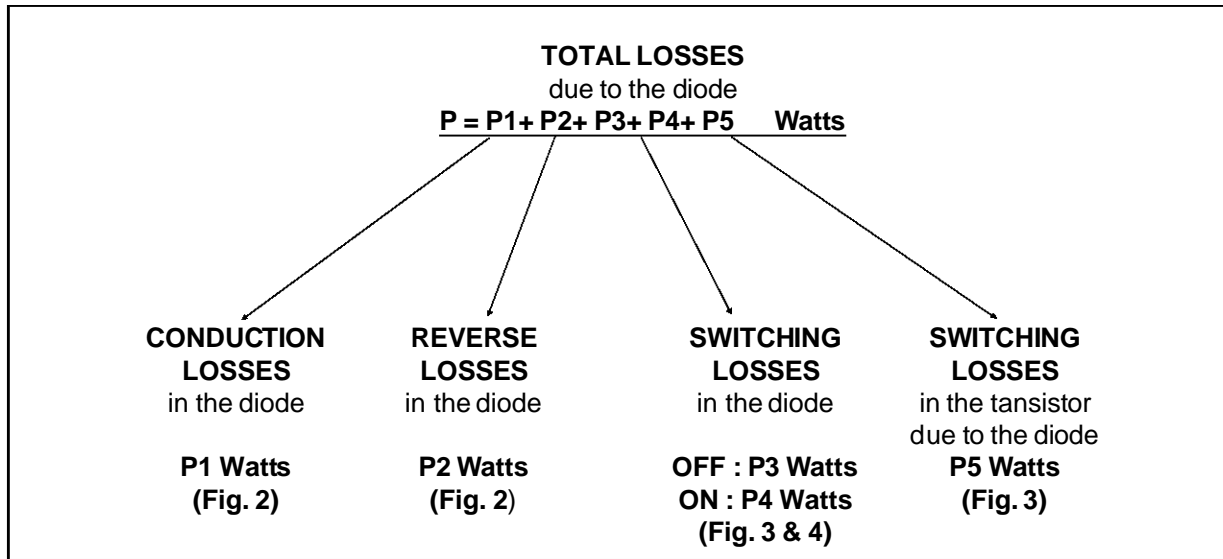
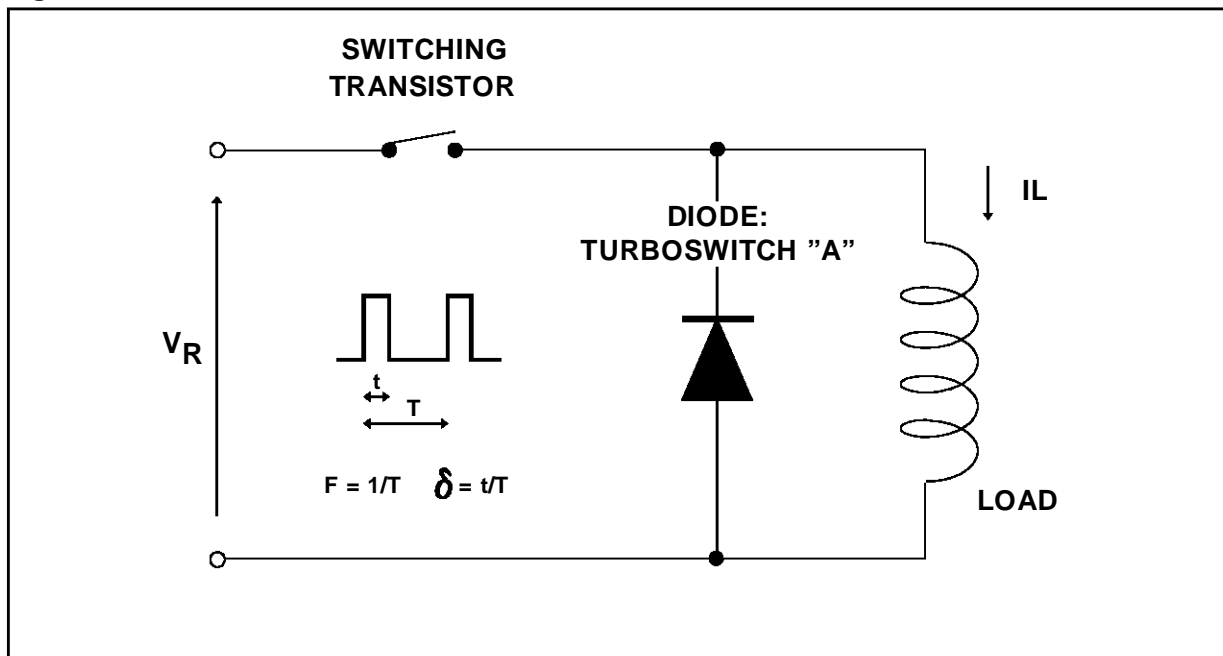
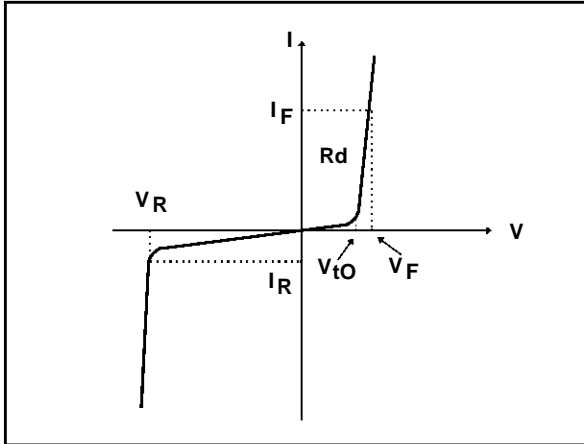


Fig. 1 : "FREEWHEEL" MODE.



APPLICATION DATA (Cont'd)

Fig. 2: STATIC CHARACTERISTICS



Conduction losses :

$$P1 = V_{t0} \cdot I_F(AV) + R_d \cdot I_F^2(RMS)$$

with

$$V_{t0} = 1.15 \text{ V}$$

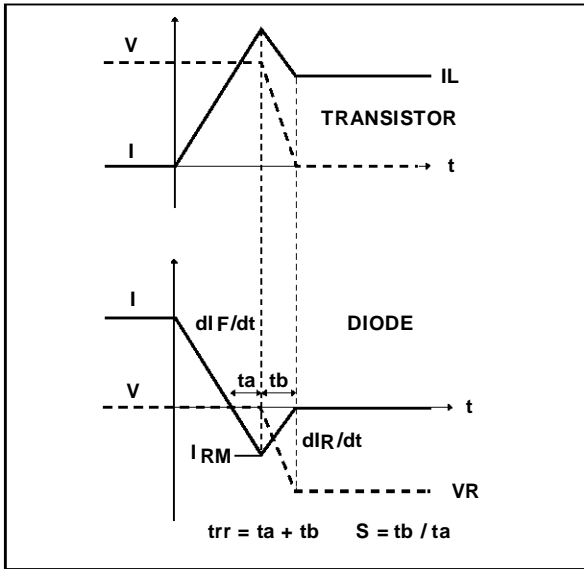
$$R_d = 0.029 \text{ Ohm}$$

(Max values at 125°C)

Reverse losses :

$$P2 = V_R \cdot I_R \cdot (1 - \delta)$$

Fig. 3: TURN-OFF CHARACTERISTICS



Turn-on losses :

(in the transistor, due to the diode)

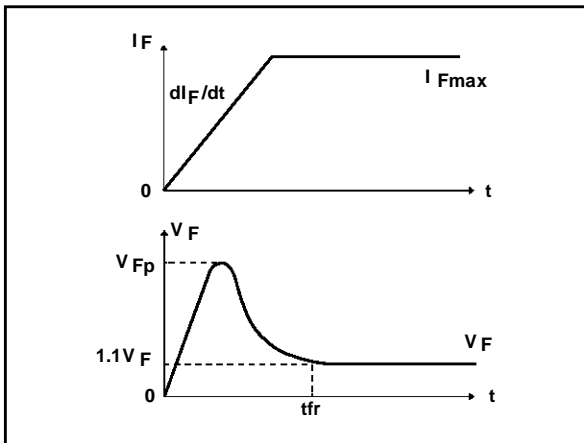
$$P5 = \frac{V_R \times I_{RM}^2 \times (3 + 2 \times S) \times F}{6 \times dI_F/dt} + \frac{V_R \times I_{RM} \times I_L \times (S + 2) \times F}{2 \times dI_F/dt}$$

Turn-off losses (in the diode) :

$$P3 = \frac{V_R \times I_{RM}^2 \times S \times F}{6 \times dI_F/dt}$$

P3 and P5 are suitable for power MOSFET and IGBT

Fig. 4: TURN-ON CHARACTERISTICS



Turn-on losses :

$$P4 = 0.4 (V_{FP} - V_F) \cdot I_{Fmax} \cdot t_{fr} \cdot F$$

Fig 5 : Conduction losses versus average current

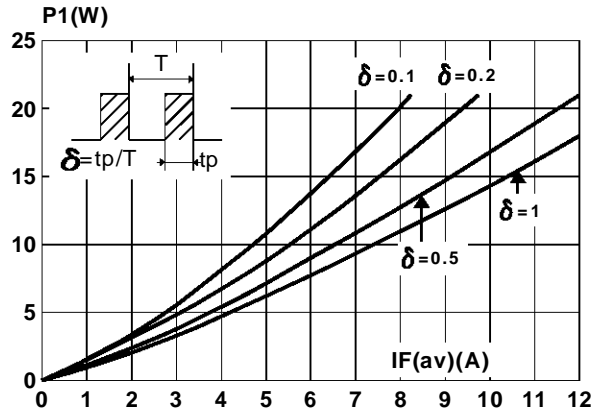


Fig 6 : Switching OFF losses versus dIF/dt

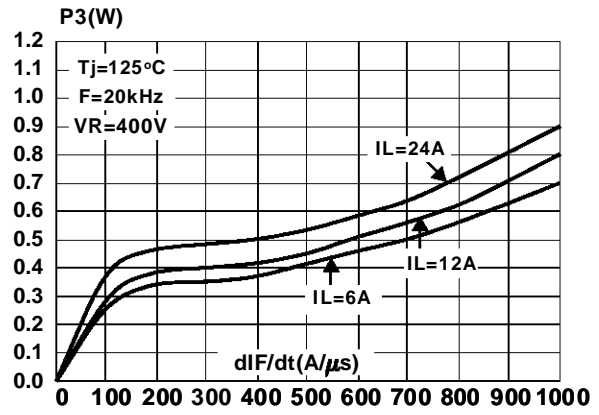


Fig 7 : Switching ON losses versus dIF/dt

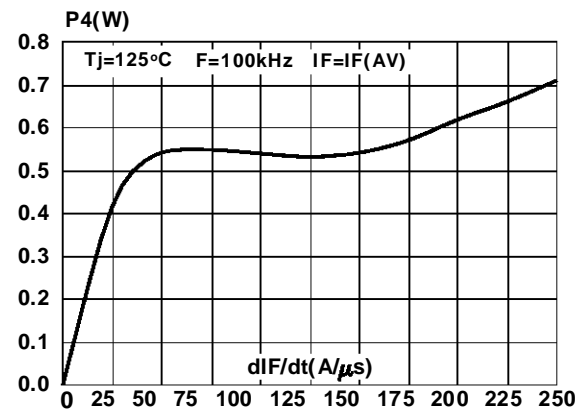


Fig 8 : Switching losses in transistor due to the diode

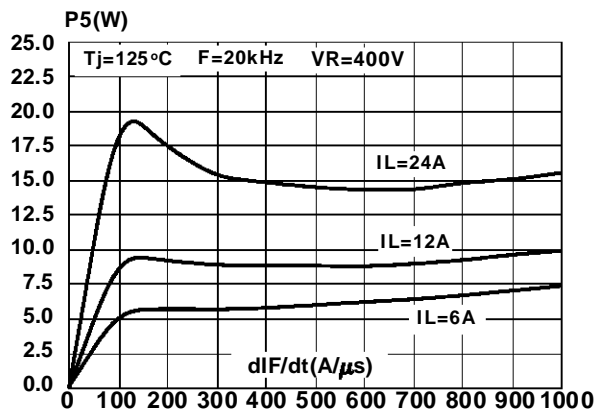


Fig 9 : Forward voltage drop versus forward current

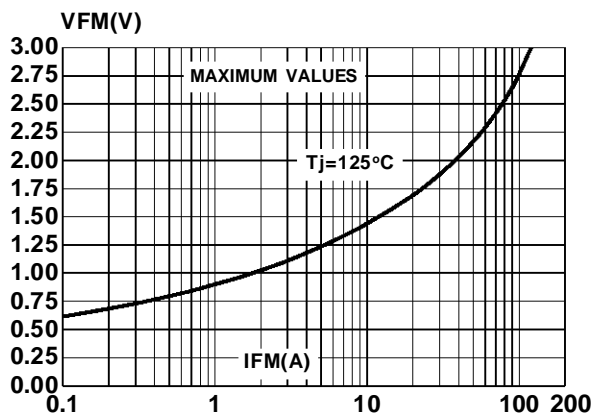


Fig 10 : Relative variation of thermal transient impedance junction to case versus pulse duration

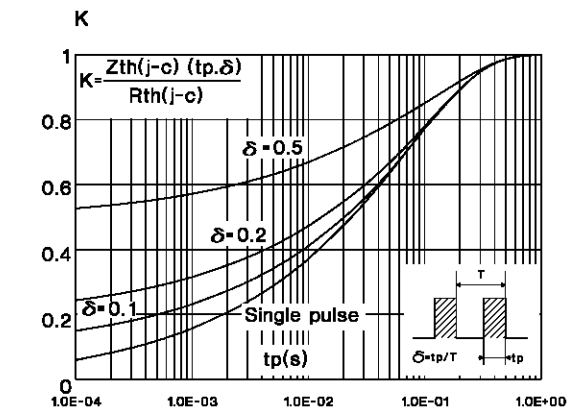


Fig 11 : Peak reverse recovery current versus dI_F/dt

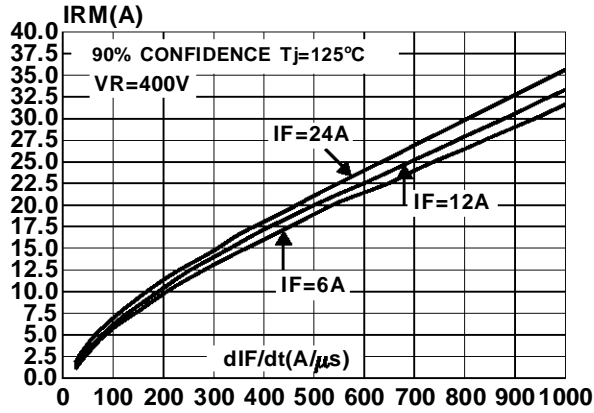


Fig 12 : Reverse recovery time versus dI_F/dt

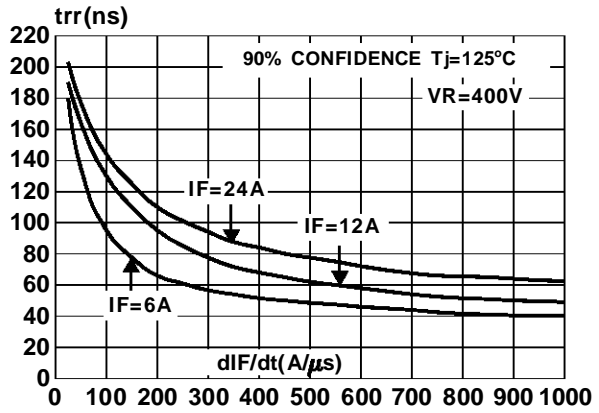


Fig 13 : Softness factor (tb/ta) versus dI_F/dt

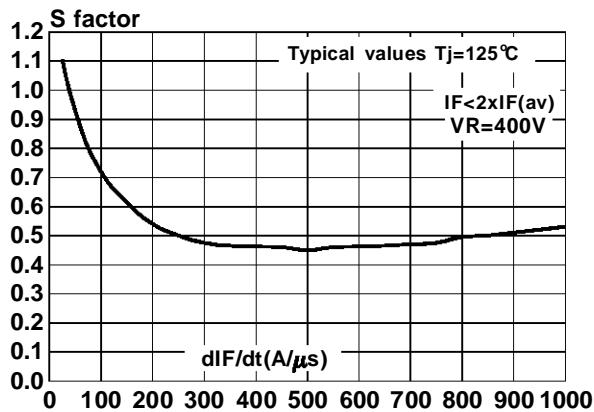


Fig 14 : Relative variation of dynamic parameters versus junction temperature (Reference $T_j = 125^\circ C$)

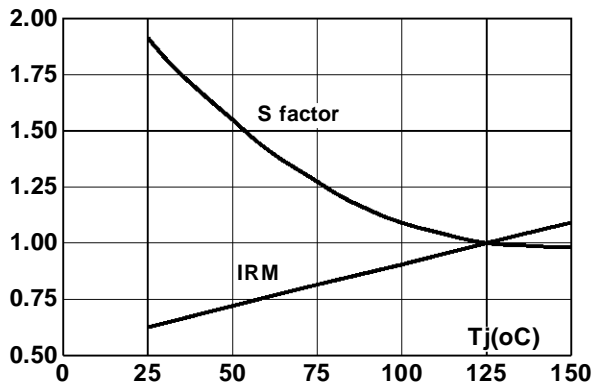


Fig 15 : Transient peak forward voltage versus dI_F/dt

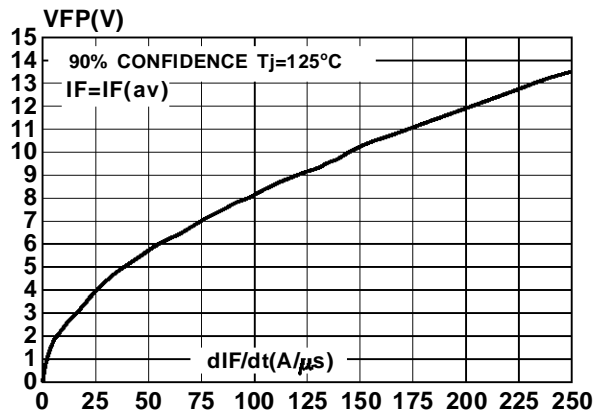
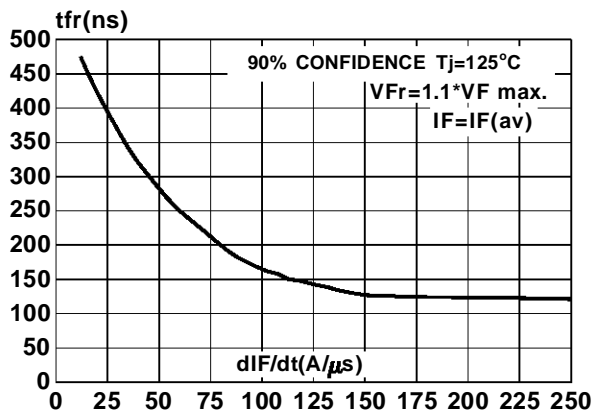
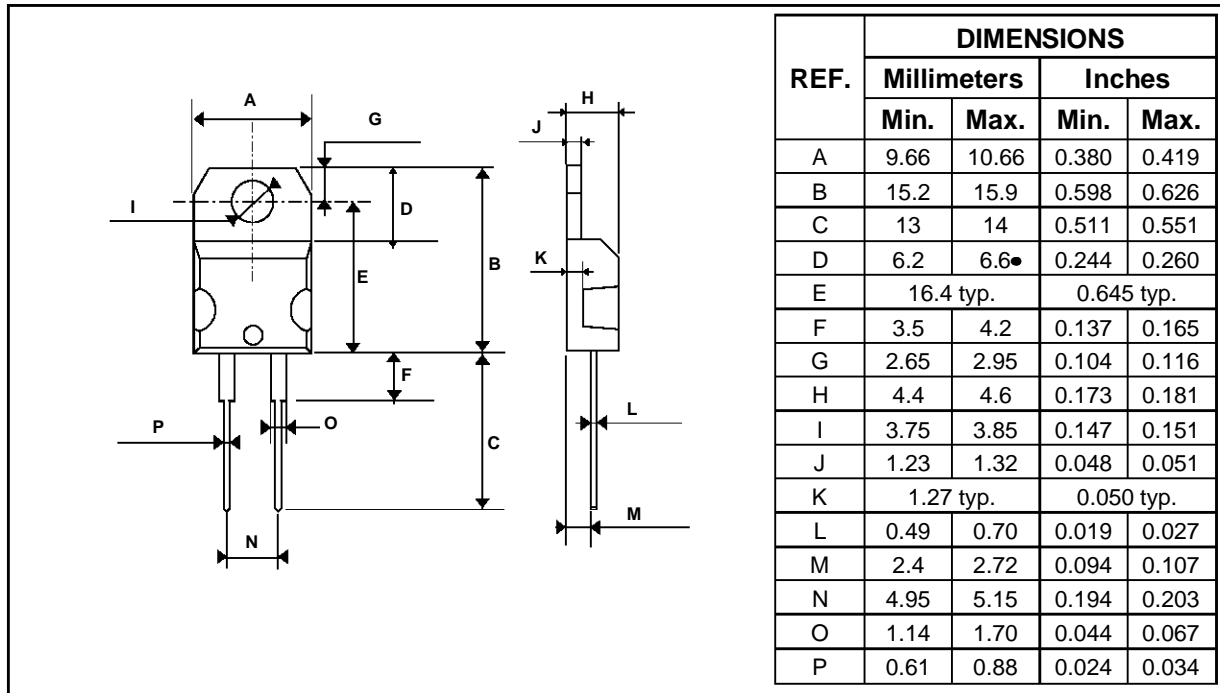
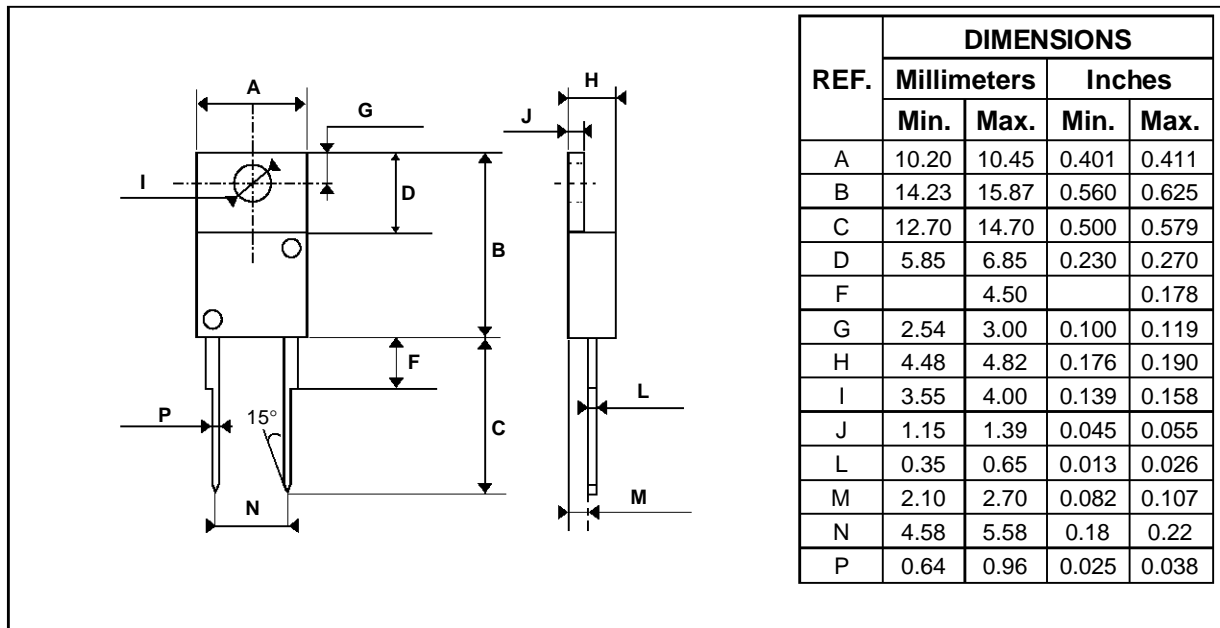


Fig 16 : Forward recovery time versus dI_F/dt



PACKAGE DATA
TO220AC (JEDEC outline)


Cooling method : C.
 Marking : Type number.
 Weight : 1.9 g.
 Torque value : 0.55 m.N typ (0.70m.N max).

PACKAGE DATA
ISOLATED TO220AC (JEDEC outline)


Cooling method : C.
 Marking : Type number.
 Weight : 2.2 g.
 Torque value : 0.8 m.N typ (1.0 m.N max).

Electrical isolation : 2500V DC
 Capacitance : 7 pF

Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.

© 1995 SGS-THOMSON Microelectronics - Printed in Italy - All rights reserved.

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands
- Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A.